COMPLIANT **HALOGEN** FREE

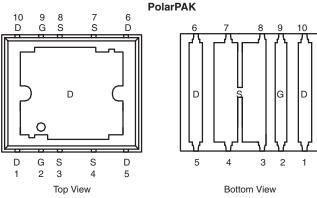


Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
		I _D (A) ^a				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	Silicon Limit	Package Limit	Q _g (Typ.)		
20	0.0035 at $V_{GS} = 4.5 \text{ V}$	136	50	43 nC		
20	0.0064 at $V_{GS} = 2.5 \text{ V}$	100	50	43110		

Package Drawing www.vishay.com/doc?73398



Top surface is connected to pins 1, 5, 6, and 10

Ordering Information: SiE820DF-T1-E3 (Lead (Pb)-free)

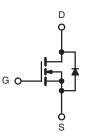
SiE820DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
- Extremely Low $\,{\rm Q}_{\rm gd}$ WFET Technology for Low Switching Losses
- TrenchFET® Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK® Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{gd}/Q_{gs} Ratio Helps Prevent Shoot-Through 100 % R_g and UIS Tested
- Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- **VRM**
- DC/DC Conversion
- Synchronous Rectification



N-Channel MOSFET For Related Documents www.vishay.com/ppg?74447

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	20	V	
Gate-Source Voltage		V_{GS}	± 12	v	
	T _C = 25 °C		136 (Silicon Limit) 50 ^a (Package Limit)		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	50 ^a		
	$T_A = 25 ^{\circ}\text{C}$ $T_A = 70 ^{\circ}\text{C}$		30 ^{b, c} 24 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	80		
Continuous Source-Drain Diode Current $T_C = 25^{\circ}$ $T_A = 25^{\circ}$		Is	50 ^a 4.3 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	30		
Avalanche Energy L = 0.1 mH		E _{AS}	45	mJ	
Maximum Dayyar Dissination	$T_C = 25 \degree C$ $T_C = 70 \degree C$	P _D	104 66	w	
Maximum Power Dissipation	$T_A = 25 ^{\circ}\text{C}$ $T_A = 70 ^{\circ}\text{C}$	'D	5.2 ^{b, c} 3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260		

Notes:

- a. Package limited is 50 A.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	20	24		
Maximum Junction-to-Case (Drain Top) ^a	Steady State	R _{thJC} (Drain)	1	1.2	°C/W	
Maximum Junction-to-Case (Source) ^{a, c}		R _{thJC} (Source)	2.8	3.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 $^{\circ}\text{C/W}.$
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1D = 250 μΑ		- 4.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.6	1.4	2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	— иА	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	25			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 18 \text{ A}$		0.0029	0.0035		
		$V_{GS} = 2.5 \text{ V}, I_D = 13.4 \text{ A}$		0.0053	0.0064	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 18 \text{ A}$		106		S	
Dynamic ^b							
Input Capacitance	C _{iss}			4300		pF	
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		950			
Reverse Transfer Capacitance	C _{rss}			450			
Total Gate Charge	Q _g	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		95	143	nC	
				43	65		
Gate-Source Charge	Q_{gs}			11.5			
Gate-Drain Charge	Q_{gd}			10			
Gate Resistance	R_{g}	f = 1 MHz		1.0	1.5	Ω	
Turn-On Delay Time	t _{d(on)}			35	55		
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.0 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω		115	175		
Turn-Off Delay Time	t _{d(off)}			105	160		
Fall Time	t _f			30	45		
Turn-On Delay Time	t _{d(on)}			15	25	ns	
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.0 Ω		35	55	115	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		55	85		
Fall Time	ì _f	•		10	15	1	
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C		50		۸	
Pulse Diode Forward Current ^a	I _{SM}				80	Α	
Body Diode Voltage	V_{SD}	I _S = 10 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			101	150	ns	
Body Diodo Povorco Pocovery Chargo		L = 10 A dl/dt = 100 A/up T = 05 °C		100	150	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		75		ns	
Reverse Recovery Rise Time	t _b			25			

Notes:

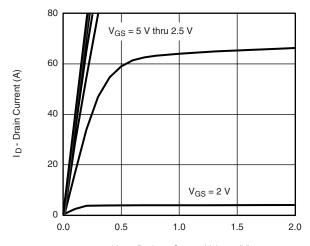
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

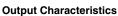


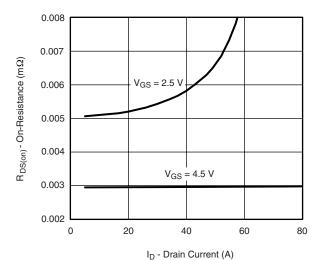


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

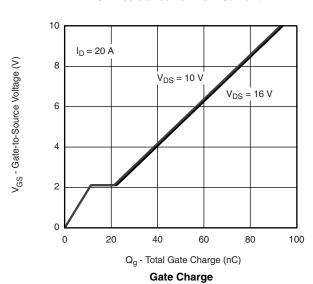


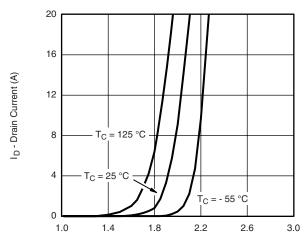
 $V_{\mbox{\footnotesize{DS}}}$ - Drain-to-Source Voltage (V)



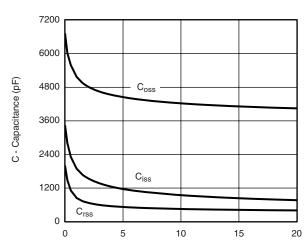


On-Resistance vs. Drain Current



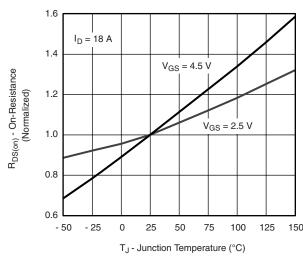


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



V_{DS} - Drain-to-Source Voltage (V)

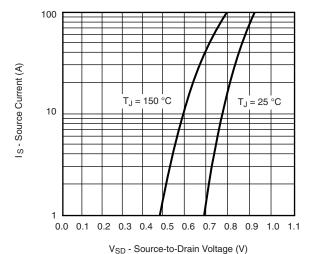
Capacitance



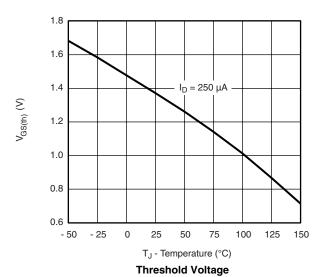
On-Resistance vs. Junction Temperature

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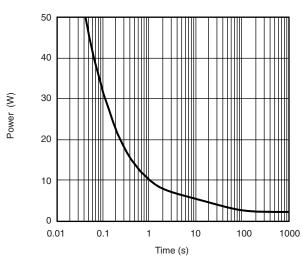
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



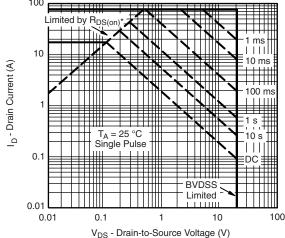
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



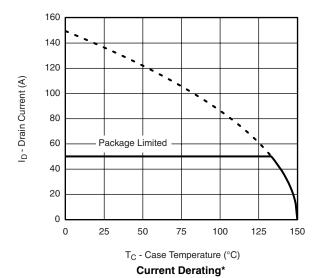
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

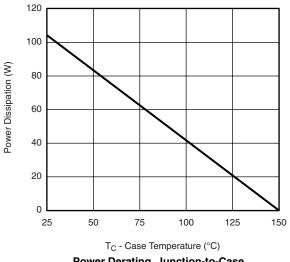
Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



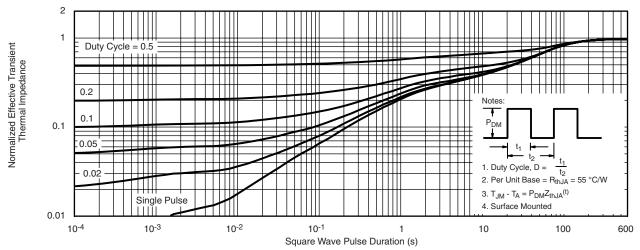


Power Derating, Junction-to-Case

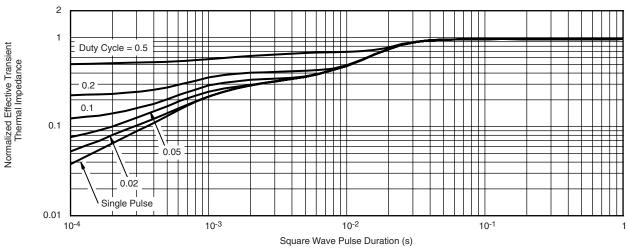
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



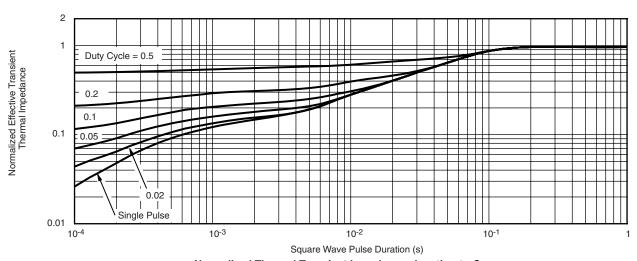
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

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